



A Product Line of Diodes Incorporated

DMN3730UFB4

Product Summary

V _{(BR)DSS}	R _{DS(on)}	Ι _D T _A = +25°C
201/	460mΩ @ V _{GS} = 4.5V	0.9A
30V	560mΩ @ V_{GS} = 2.5V	0.7A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Load Switch
- Portable Applications
- Power Management Functions

30V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

- 0.4mm ultra low profile package for thin application
- 0.6mm² package footprint, 10 times smaller than SOT23
- Low V_{GS(th)}, can be driven directly from a battery
- Low R_{DS(on)}
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- ESD Protected Gate 2kV
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

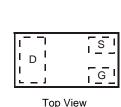
- Case: X2-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.001 grams (approximate)

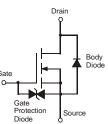




X2-DFN1006-3

Bottom View





Equivalent Circuit

Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN3730UFB4-7	NF	7	8	3000
DMN3730UFB4-7B	NF	7	8	10,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

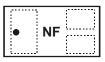
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:

DMN3730UFB4-7



Top View Dot Denotes Drain Side

DMN3730UFB4-7B



/iew

NF = Product Type Marking Code

Top View Bar Denotes Gate and Source Side

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit	
Drain-Source Voltage			V _{DSS}	30	N/	
Gate-Source Voltage			V _{GSS}	±8	V	
		(Note 6)	· I _D	0.91		
Continuous Drain Current	$V_{GS} = 4.5V$	$T_A = +70^{\circ}C$ (Note 6)		0.73	A	
		(Note 5)		0.75		
Pulsed Drain Current (Note 7)		(Note 7)	I _{DM}	3		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Dower Dissipation	(Note 6)		0.69	- W	
Power Dissipation	(Note 5)	P _D	0.47		
Thermal Desistance, lunction to Ambient	(Note 6)		180	°C/W	
Thermal Resistance, Junction to Ambient	(Note 5)	R _{0JA}	258		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Мах	Unit	Test Condition	
OFF CHARACTERISTICS	Symbol	WIIII	тур	WIAA	Onit	Test condition	
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$V_{GS} = 0V, I_{D} = 10\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	3	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS	000		I				
Gate Threshold Voltage	V _{GS(th)}	0.45	—	0.95	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
		_	—	460		V _{GS} = 4.5V, I _D = 200mA	
Static Drain-Source On-Resistance (Note 8)	R _{DS(on)}	—	_	560	mΩ	V _{GS} = 2.5V, I _D = 100mA	
		_		730		V _{GS} = 1.8V, I _D = 75mA	
Forward Transfer Admittance	Y _{fs}	40	—	—	mS	V _{DS} = 3V, I _D = 10mA	
Diode Forward Voltage (Note 8)	V _{SD}	_	0.7	1.2	V	V _{GS} = 0V, I _S = 300mA	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	64.3	—	pF		
Output Capacitance	C _{oss}	_	6.1	—	pF	−V _{DS} = 25V, V _{GS} = 0V, −f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	4.5	—	pF		
Gate Resistance	Rg	_	70	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	1.6	—	nC	V _{GS} = 4.5V, V _{DS} = 15V, 	
Gate-Source Charge	Q _{gs}	_	0.2	—	nC		
Gate-Drain Charge	Q _{gd}	_	0.2	—	nC		
Turn-On Delay Time	t _{D(on)}	_	3.5	—	ns		
Turn-On Rise Time	tr	_	2.8	—	ns	$V_{DS} = 10V, I_D = 1A$ $V_{GS} = 10V, R_G = 6 \Omega$	
Turn-Off Delay Time	t _{D(off)}	_	38	—	ns		
Turn-Off Fall Time	t _f	—	13	—	ns		

Notes: 5. For a device surface mounted on a minimum recommended pad layout of an FR4 PCB, in still air conditions; the device is measured when operating in steady-state condition.

6. Same as note 4, except the device measured at t \leq 10 sec.

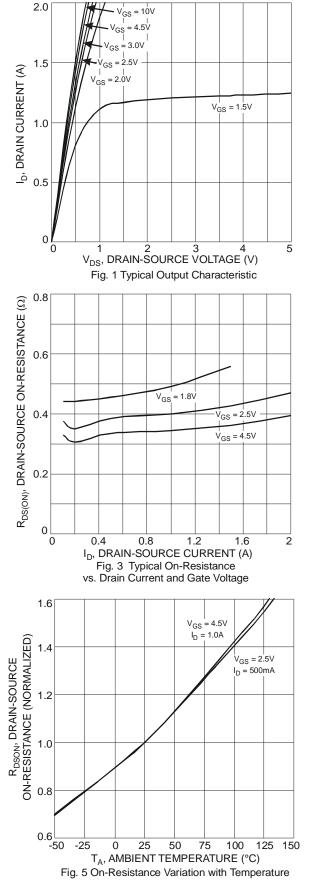
7. Same as note 4, except the device is pulsed at duty cycle of 1% for a pulse width of $10 \mu s.$

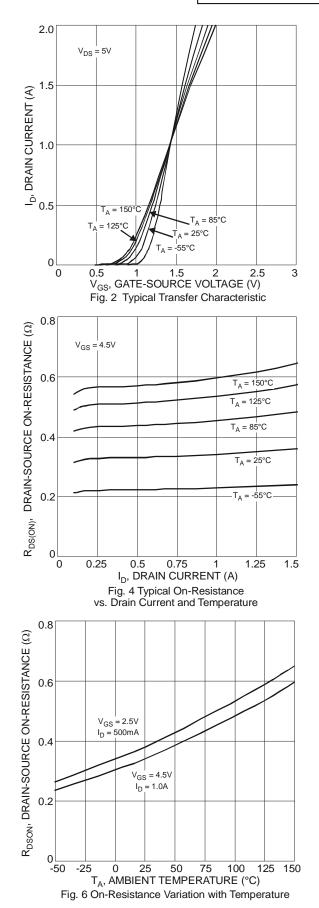
8. Measured under pulsed conditions to minimize self-heating effect. Pulse width \leq 300 μs ; duty cycle \leq 2%

9. For design aid only, not subject to production testing.









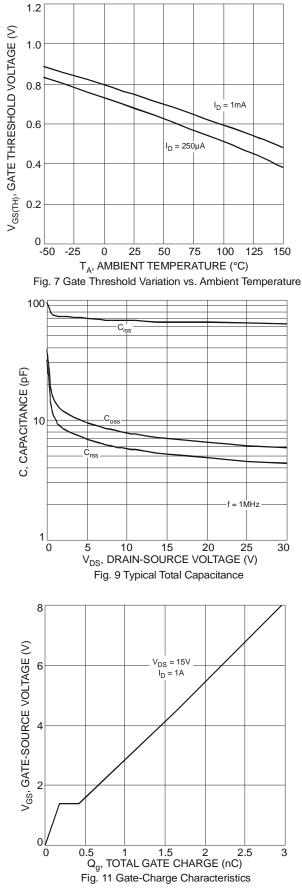
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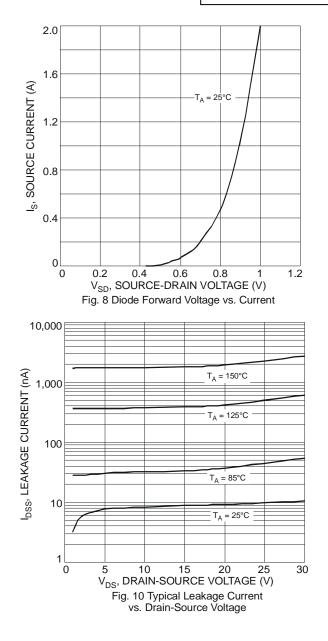


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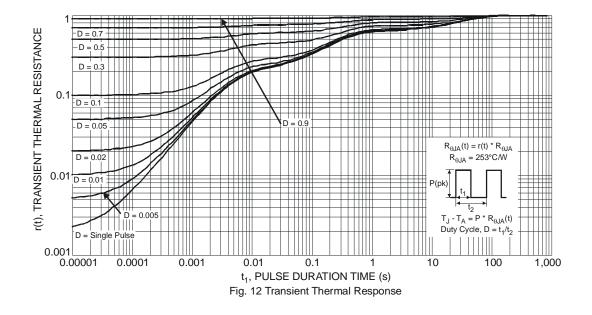


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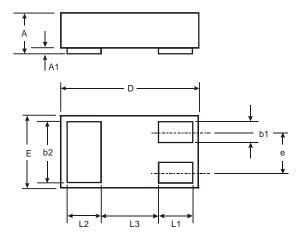






Package Outline Dimensions

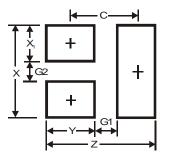
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	X2-DFN1006-3					
Dim	Min	Max	Тур			
Α	-	0.40	_			
A1	0	0.05	0.02			
b1	0.10	0.20	0.15			
b2	0.45	0.55	0.50			
D	0.95	1.075	1.00			
E	0.55	0.675	0.60			
е			0.35			
L1	0.20	0.30	0.25			
L2	0.20	0.30	0.25			
L3			0.40			
All	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	1.1
G1	0.3
G2	0.2
Х	0.7
X1	0.25
Y	0.4
С	0.7



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